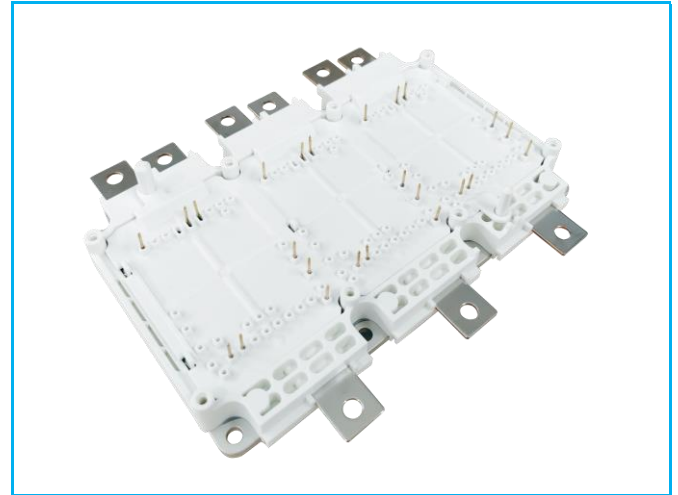


## PRODUCT FEATURES

- 750V Field Stop Trench IGBT
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Max Junction Temperature 175°C
- Temperature sense included



## APPLICATIONS

- Automotive Traction Modules
- General Power Modules

### IGBT-inverter

ABSOLUTE MAXIMUM RATINGS ( $T_F=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	750	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_{CN}$	Implemented Collector Current		820	A
$I_C$	DC Collector Current	$T_F=80^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	450	
$I_{CM}$	Repetitive Peak Collector Current	$tp=1\text{ms}$	1640	
$P_{tot}$	Power Dissipation Per IGBT	$T_F=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	1250	W

### Diode-inverter

ABSOLUTE MAXIMUM RATINGS ( $T_F=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	750	V
$I_{FN}$	Implemented Forward Current		820	A
$I_{F(AV)}$	Average Forward Current		450	
$I_{FRM}$	Repetitive Peak Forward Current	$tp=1\text{ms}$	1640	
$I^2t$		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	28.8	$\text{KA}^2\text{s}$

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# MMG820V075X6T7

## IGBT-inverter

### ELECTRICAL CHARACTERISTICS ( $T_F=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=9.6\text{mA}$	5.1	5.9	6.7	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.1		
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		1.14		
		$I_C=820\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.3		
		$I_C=820\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		1.5		
$I_{CES}$	Collector Leakage Current	$V_{CE}=750\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA
		$V_{CE}=750\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			5	mA
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-400		400	nA
$R_{Gint}$	Integrated Gate Resistor			0.6		$\Omega$
$Q_G$	Gate Charge	$V_{CE}=400\text{V}, I_C=450\text{A}, V_{GE}=15\text{V}$		2.3		$\mu\text{C}$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		86		nF
$C_{oes}$	Output Capacitance			2.3		nF
$C_{res}$	Reverse Transfer Capacitance			0.38		nF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}$ $R_G=2.7\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		175	ns
			$T_J=150^\circ\text{C}$		185	ns
$t_r$	Rise Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		70	ns
			$T_J=150^\circ\text{C}$		80	ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}$ $R_G=2.7\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		520	ns
			$T_J=150^\circ\text{C}$		580	ns
$t_f$	Fall Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		60	ns
			$T_J=150^\circ\text{C}$		110	ns
$E_{on}$	Turn on Energy	$V_{CC}=400\text{V}, I_C=450\text{A}$ $R_G=2.7\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		11.6	mJ
			$T_J=150^\circ\text{C}$		20.2	mJ
$E_{off}$	Turn off Energy	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		19.0	mJ
			$T_J=150^\circ\text{C}$		26.4	mJ
$I_{SC}$	Short Circuit Current	$tpsc \leq 6\mu\text{s}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=400\text{V}$		4000		A
$R_{thJF}$	Junction to cooling fluid, $\Delta V/\Delta t = 10 \text{ dm}^3/\text{min}, T_F = 25^\circ\text{C}$ ( Per IGBT )				0.12	K /W

## Diode-inverter

### ELECTRICAL CHARACTERISTICS ( $T_F=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=450\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.4		V
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.4		
		$I_F=820\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.7		
		$I_F=820\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.8		
$t_{rr}$	Reverse Recovery Time	$I_F=450\text{A}, V_R=400\text{V}$ $dI_F/dt=-8000\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		200		ns
$I_{RRM}$	Max. Reverse Recovery Current			440		A
$Q_{RR}$	Reverse Recovery Charge			60		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy			19.5		mJ
$R_{thJF}$	Junction to cooling fluid, $\Delta V/\Delta t = 10 \text{ dm}^3/\text{min}, T_F = 25^\circ\text{C}$ ( Per Diode )				0.2	K /W

## MMG820V075X6T7

### NTC CHARACTERISTICS ( $T_F=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
$R_{25}$	Resistance $T_F=25^\circ\text{C}$		5		k $\Omega$
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$		3375		K

### MODULE CHARACTERISTICS ( $T_F=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit	
$T_{Jmax}$	Max. Junction Temperature	175	°C	
$T_{Jop}$	Operating Temperature	-40~150		
$T_{stg}$	Storage Temperature	-40~125		
$V_{isol}$	Isolation Breakdown Voltage RMS, f = 0 Hz, t = 1 sec	4200	V	
CTI	Comparative Tracking Index	> 200		
Torque	baseplate to heatsink	Recommended (M4)	1.8~2.2	Nm
	PCB to frame	Recommended (M3)	0.4~0.6	Nm
Weight		775	g	

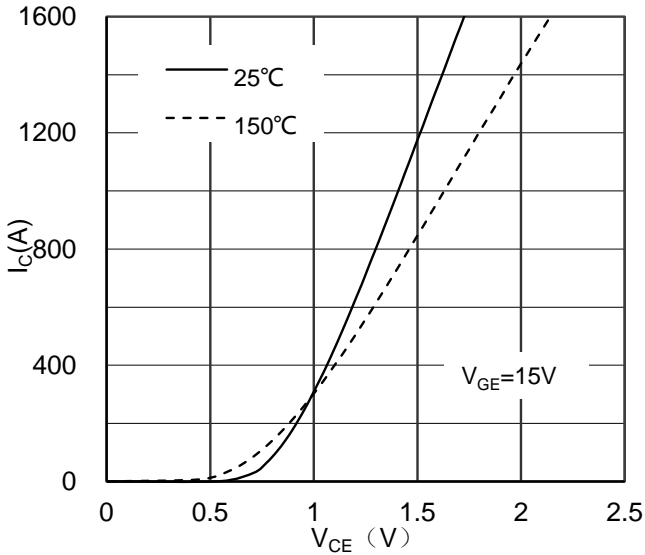


Figure 1. Typical Output Characteristics IGBT-inverter

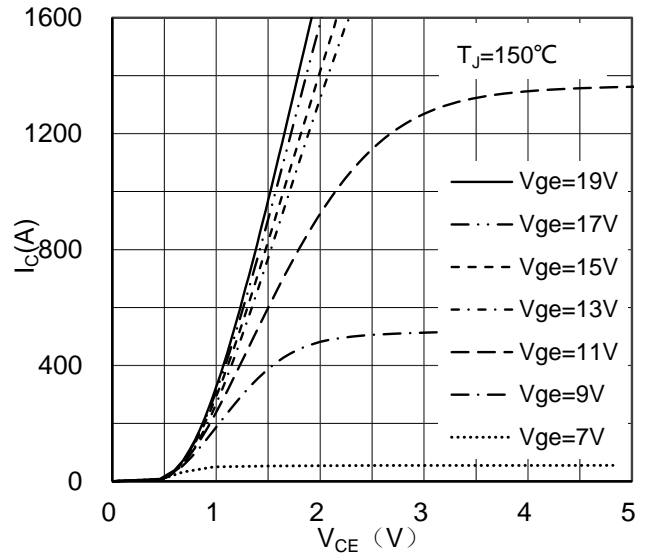


Figure 2. Typical Output Characteristics IGBT-inverter

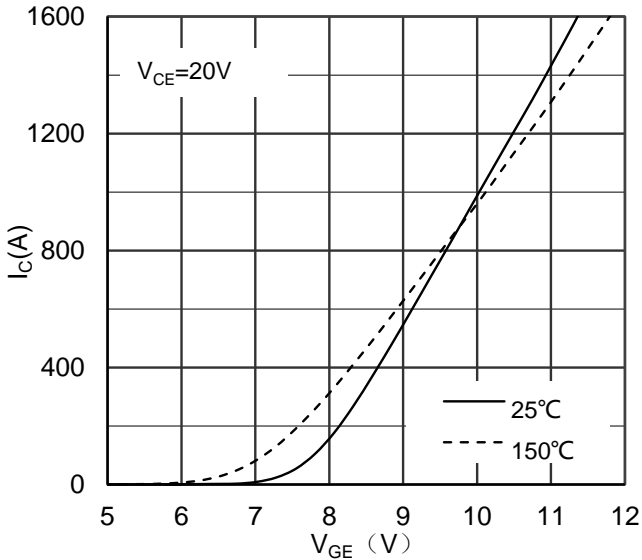


Figure 3. Typical Transfer characteristics IGBT-inverter

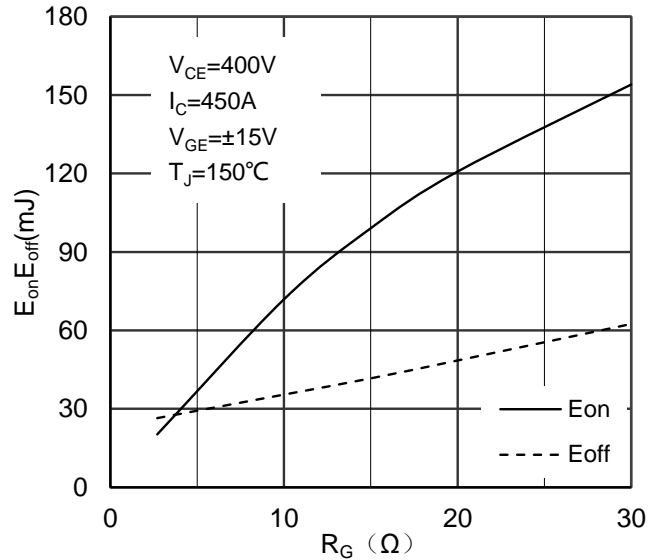


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

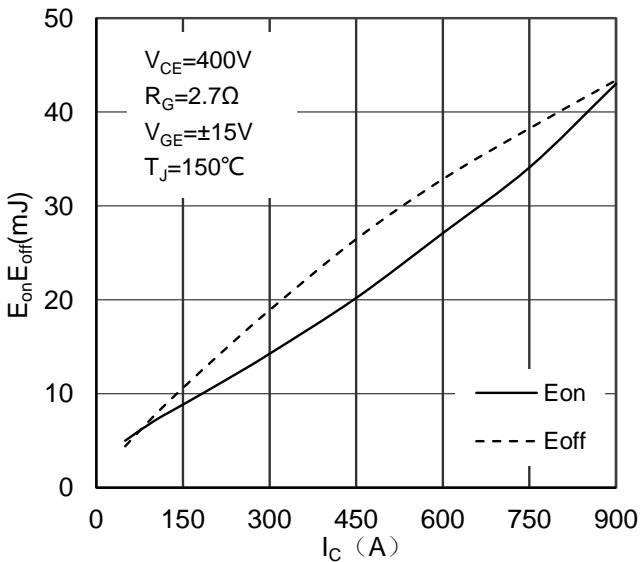


Figure 5. Switching Energy vs Collector Current IGBT-inverter

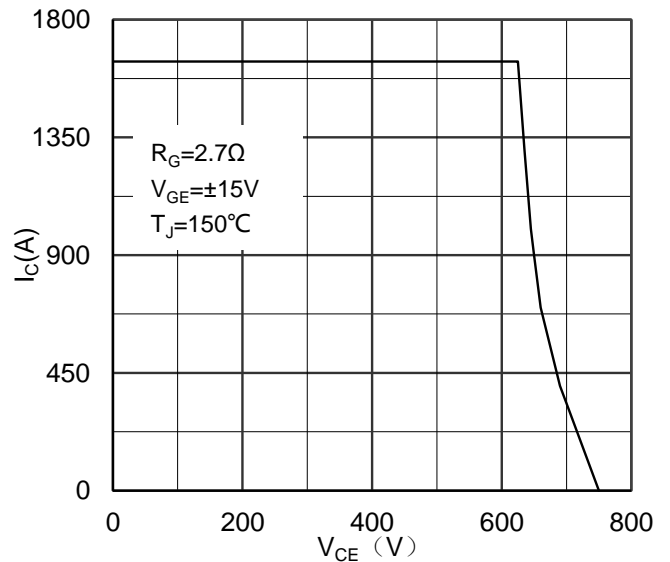


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

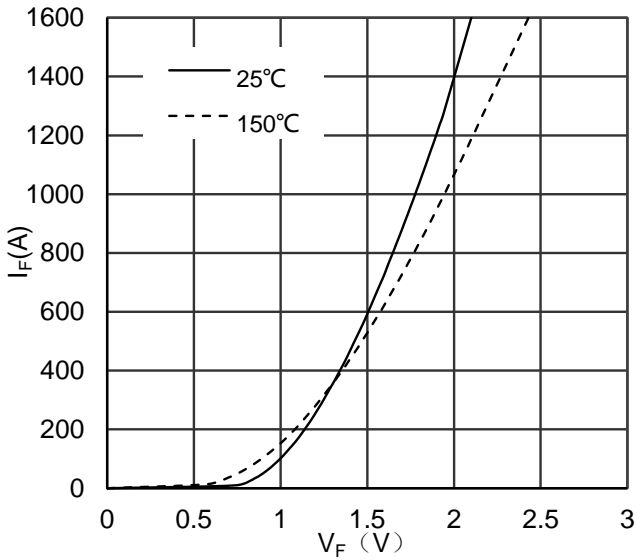


Figure 7. Diode Forward Characteristics Diode-inverter

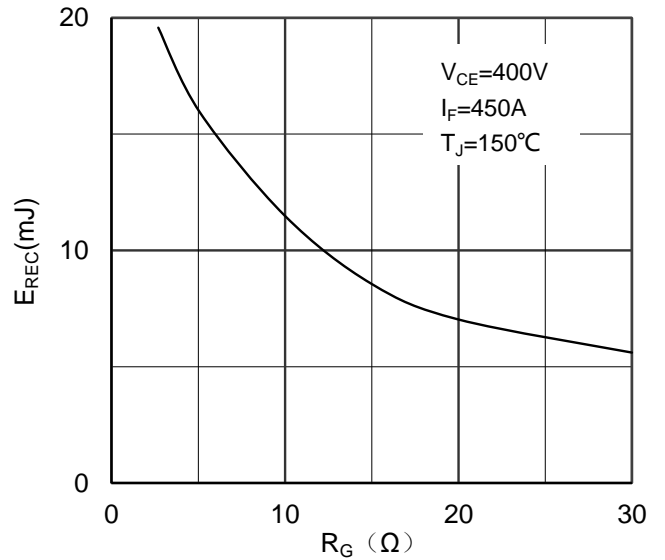


Figure 8. Switching Energy vs Gate Resistor Diode-inverter

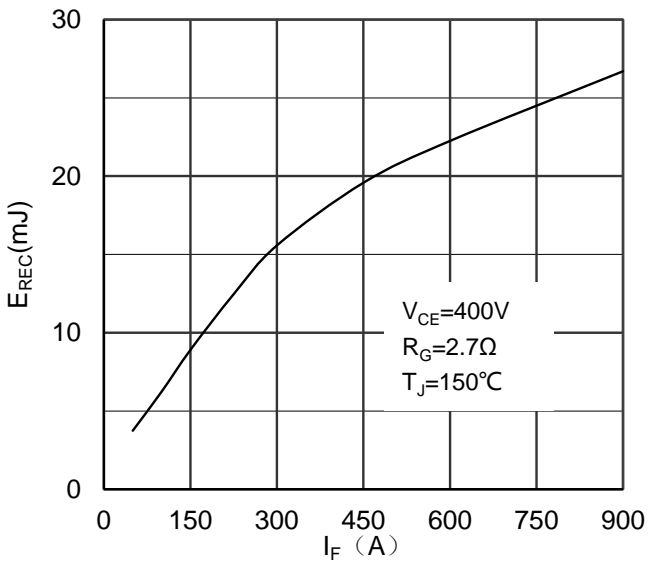


Figure 9. Switching Energy vs Forward Current Diode-inverter

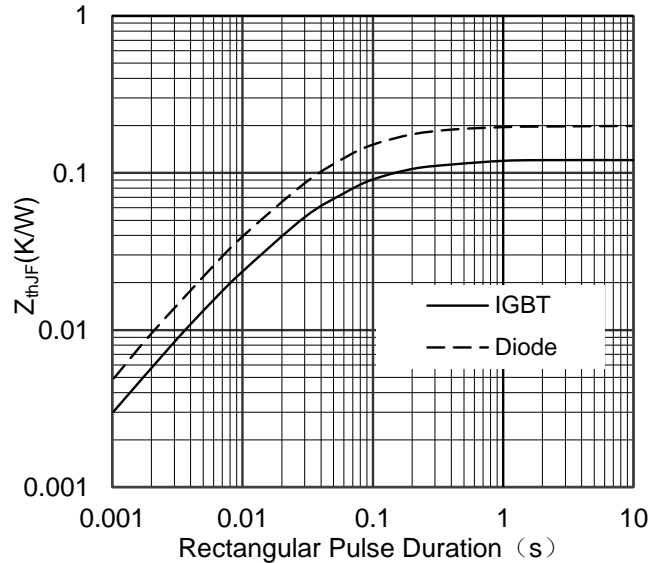


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

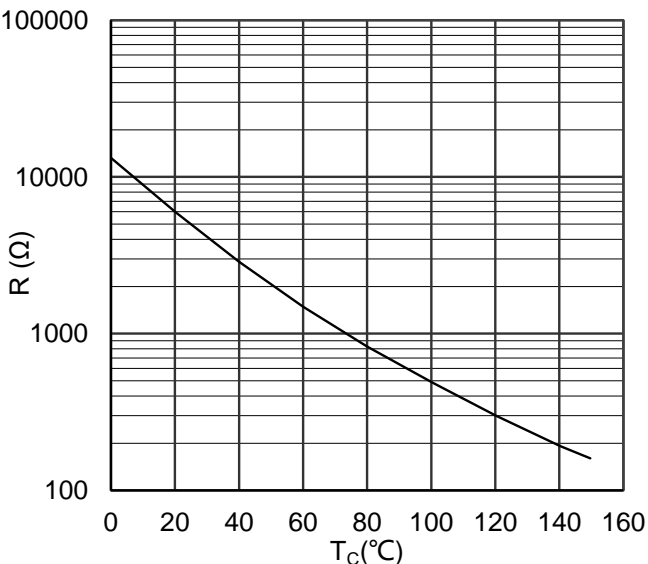


Figure 11. NTC Characteristics

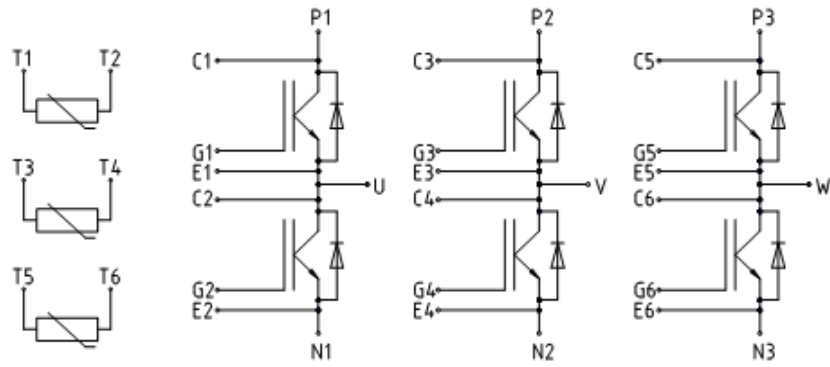


Figure 12. Circuit Diagram

